



SURFACE-MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _R (V)	I _F (mA)	V _{F MAX} (V) @ +25°C	Ir max (μA) @ +25°C
30	200	0.575	150

Features and Benefits

- Low-Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Low Capacitance
- Ultra-Small Surface-Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The SDM20U30LPQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Applications

- SMPS
- Free wheeling diodes
- Reverse polarity protections
- DC-DC converters
- General switching applications

Mechanical Data

- Package: X1-DFN1006-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot or Bar
- Terminals: Finish NiPdAu Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Top View



Bottom View

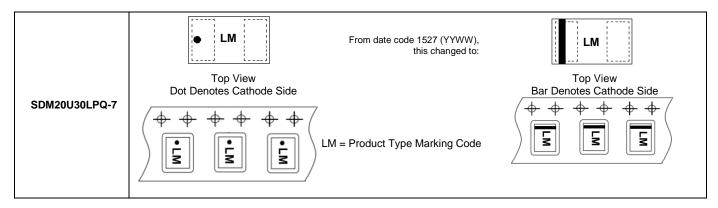
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
SDM20U30LPQ-7	X1-DFN1006-2	3,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		VRRM VRWM VR	30	V
RMS Reverse Voltage		V _R (RMS)	21	V
Maximum (Peak) Forward Current		l _F	200	mA
Peak Forward Surge Current	8.3ms Half Sine	IFSM	1.0	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	Reja	400	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +125	°C

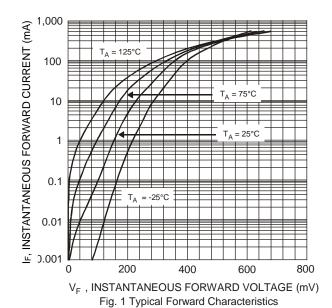
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

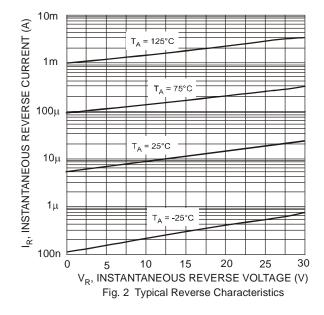
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	30			V	I _R = 150μA
Forward Voltage Drop	VF	_	_	350 575	mV	I _F = 20mA I _F = 200mA
Peak Reverse Current (Note 6)	I _R	_	_	150 30		V _R = 30V V _R = 10V
Total Capacitance	Ст	_	20		pF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time	t _{RR}	_	3		ns	$ I_F = I_R = 10 mA, \ I_{R(REC)} = 1 mA, $ $ R_L = 100 \Omega $

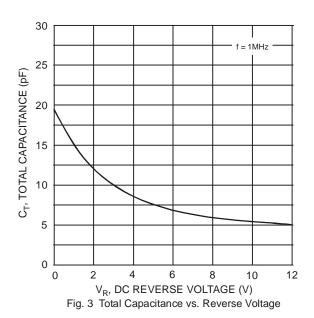
Notes:

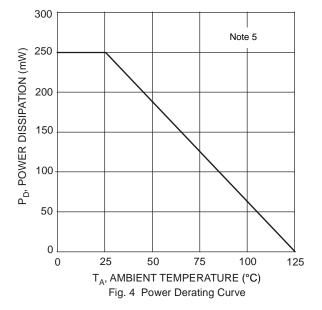
- 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.
- 6. Short duration pulse test used to minimize self-heating effect.









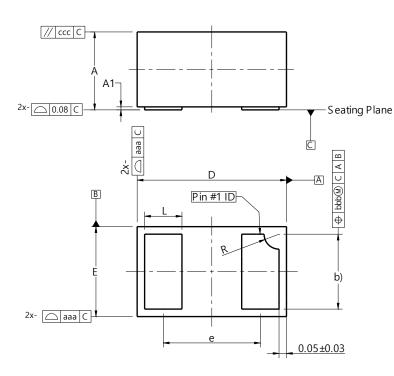




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2

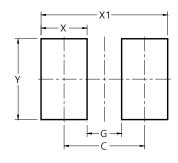


X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0.00	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е			0.65		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
aaa	0.15				
bbb	0.05				
CCC	0.05				
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value		
Dillielisions	(in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Υ	0.70		



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